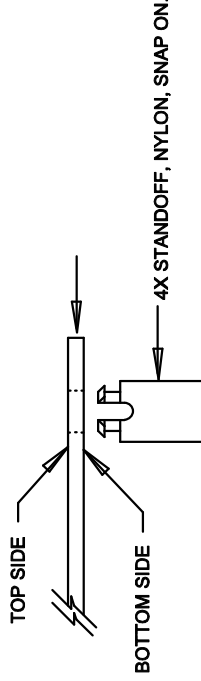


REVISION HISTORY			
ECO	REV	DESCRIPTION	APPROVAL
	2	PRODUCTION	JON M.
			DATE
			07/02/10

NOTES: UNLESS OTHERWISE SPECIFIED,

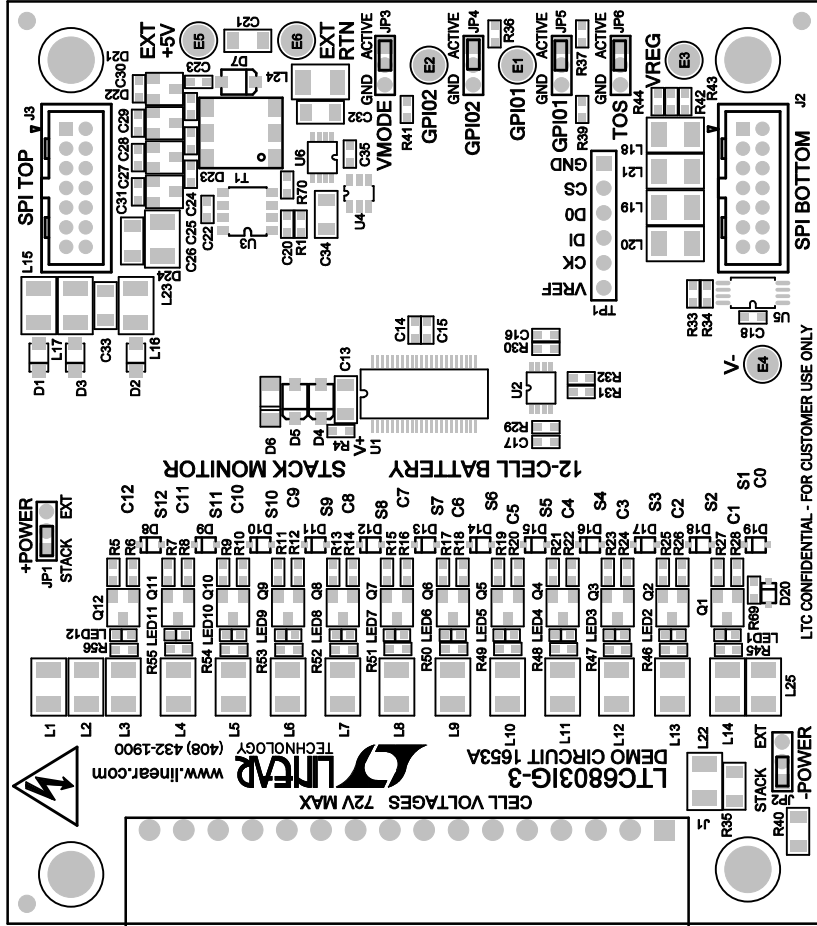
1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS.  
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.  
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE  
BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP  
TO ANY BOARD.
7. INSTALL 4 STANDOFFS AT 4 LOCATIONS AS SHOWN BELOW:



TITLE: TOP ASSEMBLY DRAWING,  
12-CELL BATTERY STACK MONITOR

SIZE	IC NO	REV
N/A	LTC6803IG-3	2
FILENAME: 1653A-2.PCB		SHT 1 of 2

APPROVALS	
PCB DES.	MI
APP. ENG.	JON M.
SCALE: NONE	



TOP SILKSCREEN